&TDK Multilayer Ceramic Chip Capacitors

C1005X5R1V334M050BC



TDK item description C1005X5R1V334MT****

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Applications	Commercial Grade	
Feature	General General (Up to 50V)	
Series	C1005 [EIA 0402]	6
Status	Production (Not Recommended for New Design)	Dimensions in mr

	Size
Length(L)	1.00mm ±0.05mm
Width(W)	0.50mm ±0.05mm
Thickness(T)	0.50mm ±0.05mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.30mm to 0.50mm
Recommended Land Pattern (PB)	0.35mm to 0.45mm
Recommended Land Pattern (PC)	0.40mm to 0.60mm

Electrical Characteristics		
Capacitance	330nF ±20%	
Rated Voltage	35VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	1515ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

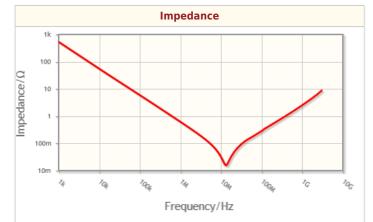
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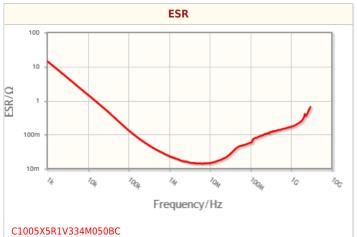
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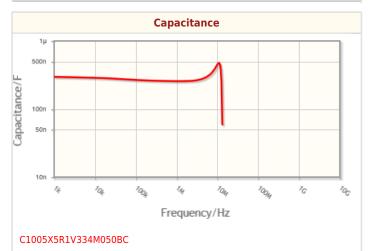


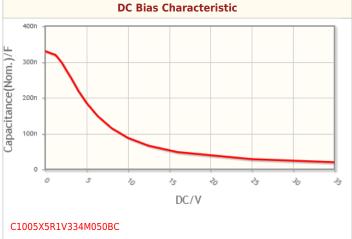


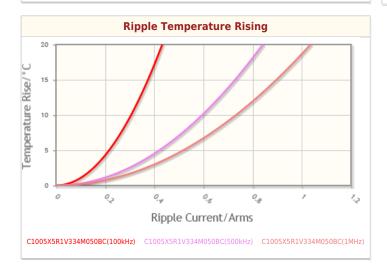


Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

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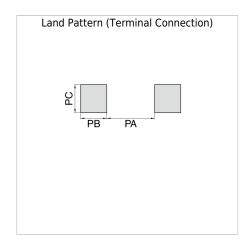
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